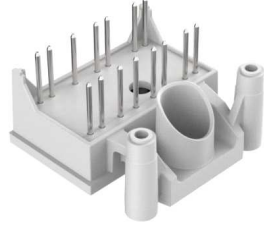
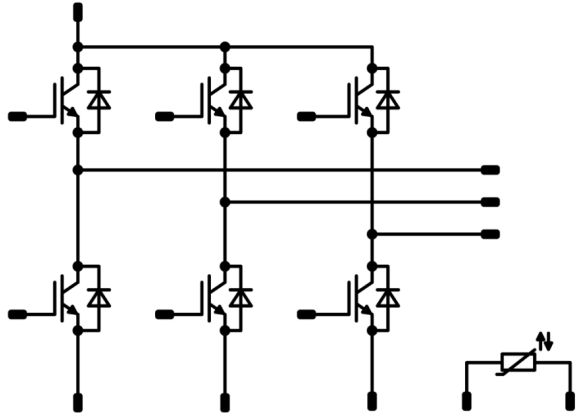




Vincotech

<i>flow</i> PACK 0 B	600 V / 15 A
<div style="background-color: #ccc; padding: 2px; text-align: center; font-weight: bold; margin-bottom: 5px;">Features</div> <ul style="list-style-type: none"> IGBT3 (600 V) technology Open emitter topology New ultra-compact housing Single-screw heat sink mounting 	<div style="background-color: #ccc; padding: 2px; text-align: center; font-weight: bold; margin-bottom: 5px;"><i>flow</i> 0 B 17mm housing</div> 
<div style="background-color: #ccc; padding: 2px; text-align: center; font-weight: bold; margin-bottom: 5px;">Target applications</div> <ul style="list-style-type: none"> Dedicated design for motor drive 	<div style="background-color: #ccc; padding: 2px; text-align: center; font-weight: bold; margin-bottom: 5px;">Schematic</div> 
<div style="background-color: #ccc; padding: 2px; text-align: center; font-weight: bold; margin-bottom: 5px;">Types</div> <ul style="list-style-type: none"> 10-0B066PA015SB-M994F09 	

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Inverter Switch				
Collector-emitter voltage	V_{CES}		600	V
Collector current	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	18	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	45	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	40	W
Gate-emitter voltage	V_{GES}		±20	V
Short circuit ratings	t_{SC} V_{CC}	$T_j \leq 150\text{ °C}$ $V_{GE} = 15V$	6 360	µs V
Maximum Junction Temperature	T_{jmax}		175	°C



Vincotech

Parameter	Symbol	Condition	Value	Unit
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Inverter Diode

Peak Repetitive Reverse Voltage	V_{RRM}		600	V
Continuous (direct) forward current	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	19	A
Repetitive peak forward current	I_{FRM}		30	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	31	W
Maximum Junction Temperature	T_{jmax}		175	°C

Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	°C
Operation temperature under switching condition	T_{jop}		-40...+($T_{jmax} - 25$)	°C

Isolation Properties

Isolation voltage	V_{isol}	DC Voltage $t_p = 2s$	4000	V
Creepage distance			min. 12,7	mm
Clearance			min. 12,7	mm
Comparative Tracking Index	CTI		> 200	



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Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{GS} [V] V_r [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

Inverter Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}$			0,00021	25 125	5	5,8	6,5	V
Collector-emitter saturation voltage	V_{CEsat}		15		15	25 150	1,1	1,59 1,85	1,9	V
Collector-emitter cut-off current	I_{CES}		0	600		25 125			0,85	μA
Gate-emitter leakage current	I_{GES}		20	0		25 125			300	nA
Internal gate resistance	r_g							none		Ω
Input capacitance	C_{ies}	f = 1 MHz	0	25		25		860		pF
Output capacitance	C_{oes}							55		
Reverse transfer capacitance	C_{res}							24		
Gate charge	Q_g		15	480	15	25		87		nC

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	Thermal grease thickness ≤ 50 μm λ = 1 W/mK						2,40		K/W
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IGBT Switching

Turn-on delay time	$t_{d(on)}$	$R_{goff} = 32 \Omega$ $R_{gon} = 32 \Omega$	±15	300	15	25		106		ns
Rise time	t_r					150		105		
Turn-off delay time	$t_{d(off)}$					25		15		
Fall time	t_f					150		18		
Turn-on energy (per pulse)	E_{on}	$Q_{rFWD} = 0,7 \mu C$ $Q_{rFWD} = 1,4 \mu C$				25		0,276		mWs
Turn-off energy (per pulse)	E_{off}					150		0,380		
						25		0,345		
						150		0,459		



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Parameter	Symbol	Conditions					Value			Unit	
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{GS} [V]	V_r [V]	I_C [A]	I_D [A]	I_F [A]		T_j [°C]

Inverter Diode

Static

Forward voltage	V_F				15	25 150		1,60 1,51	1,95	V
Reverse leakage current	I_r			600		25			27	μ A

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	Thermal grease thickness $\leq 50 \mu$ m $\lambda = 1$ W/mK						3,10		K/W
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FWD Switching

Peak recovery current	I_{RRM}	$di/dt = 1184$ A/ μ s $di/dt = 1026$ A/ μ s	± 15	300	15	25		11		A
Reverse recovery time	t_{rr}					150		16		
						25		180		ns
Recovered charge	Q_r					150		0,715		μ C
						25		1,445		
Reverse recovered energy	E_{rec}	150		0,159		mWs				
		25		0,306						
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25		470		A/ μ s
						150		194		

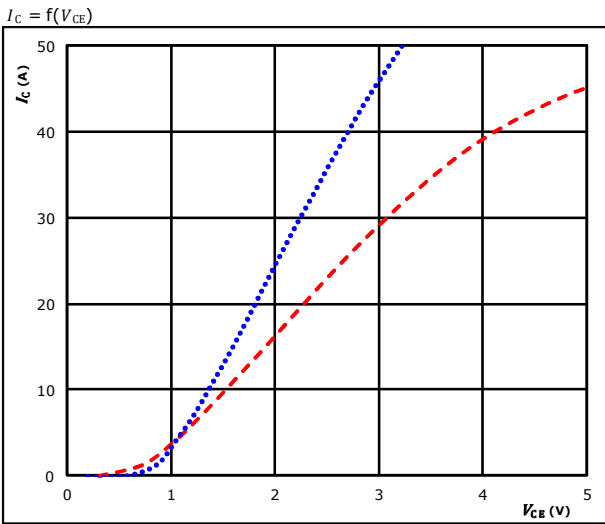
Thermistor

Rated resistance	R					25		21,5		k Ω
Deviation of R100	$\Delta_{R/R}$	R100=1486 Ω				100	-4,5		+4,5	%
Power dissipation	P					25		210		mW
Power dissipation constant						25		3,5		mW/K
B-value	$B_{(25/50)}$					25		3884		K
B-value	$B_{(25/100)}$					25		3964		K
Vincotech NTC Reference									F	



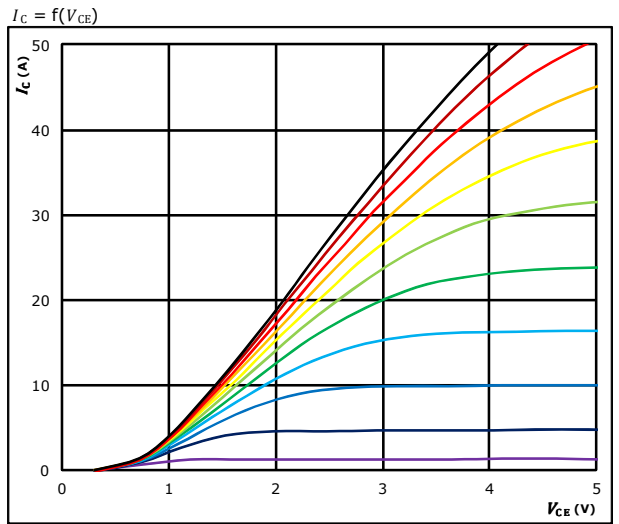
Inverter Switch Characteristics

Typical output characteristics IGBT



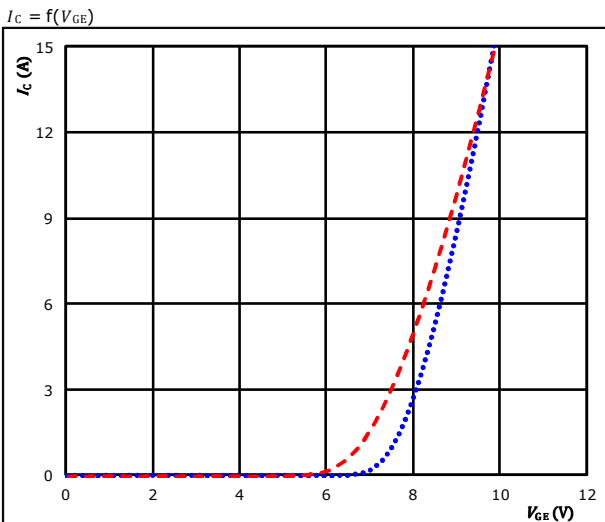
$t_p = 250 \mu s$
 $V_{GE} = 15 V$
 $T_j: 25 \text{ }^\circ C$ (blue dotted)
 $150 \text{ }^\circ C$ (red dashed)

Typical output characteristics IGBT



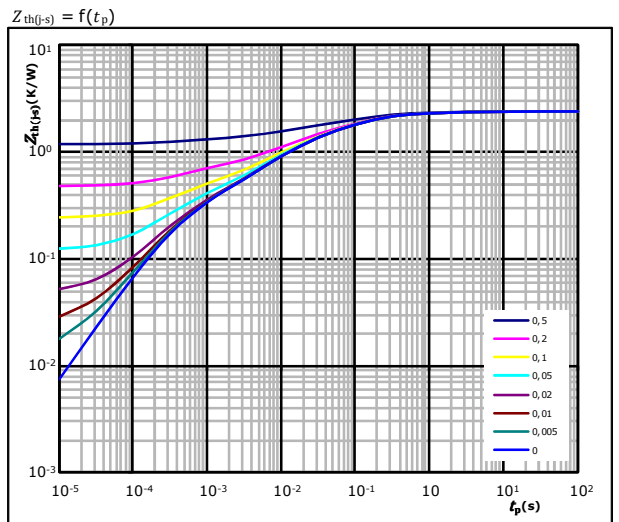
$t_p = 250 \mu s$
 $T_j = 150 \text{ }^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

Typical transfer characteristics IGBT



$t_p = 100 \mu s$
 $V_{CE} = 10 V$
 $T_j: 25 \text{ }^\circ C$ (blue dotted)
 $150 \text{ }^\circ C$ (red dashed)

Transient Thermal Impedance as function of Pulse duration IGBT



$D = t_p / T$
 $R_{th(j-s)} = 2,40 \text{ K/W}$
 IGBT thermal model values

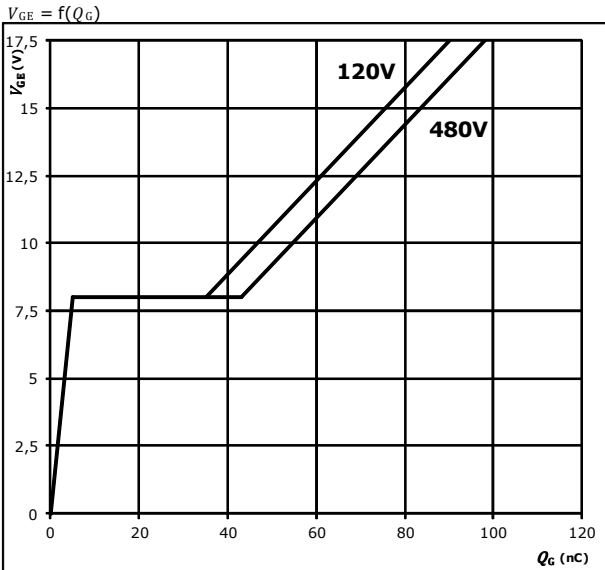
R (K/W)	τ (s)
4,32E-02	7,18E+00
2,14E-01	7,90E-01
8,50E-01	1,13E-01
7,21E-01	1,91E-02
3,38E-01	3,73E-03
2,33E-01	3,73E-04



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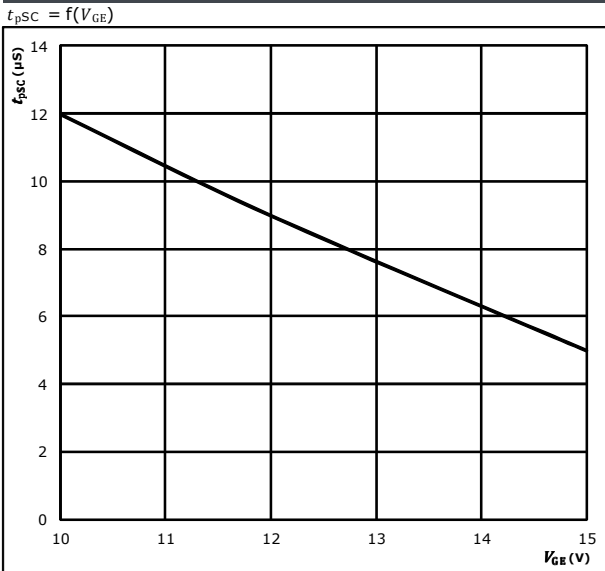
Inverter Switch Characteristics

Gate voltage vs Gate charge IGBT



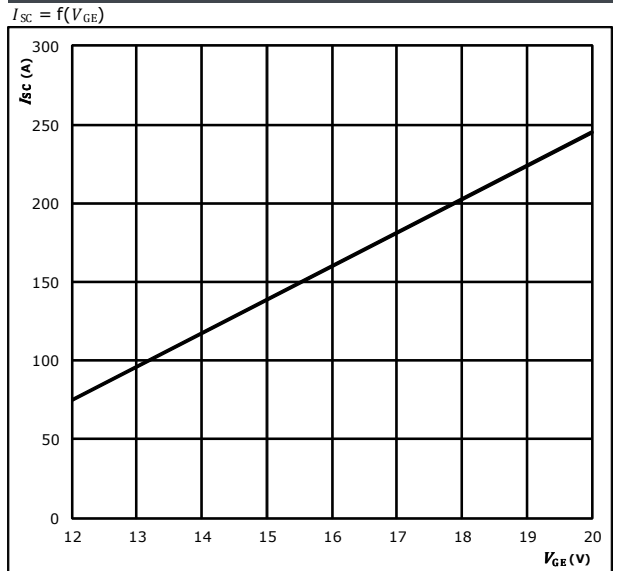
At
 $I_C = 15$ A

Short circuit duration as a function of V_{GE} IGBT



At
 $V_{CE} = 600$ V
 $T_j \leq 175$ °C

Typical short circuit current as a function of V_{GE} IGBT



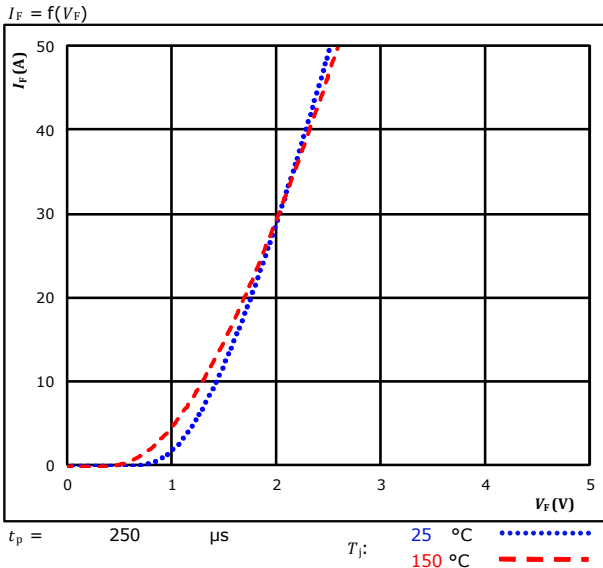
At
 $V_{CE} \leq 600$ V
 $T_j \leq 175$ °C



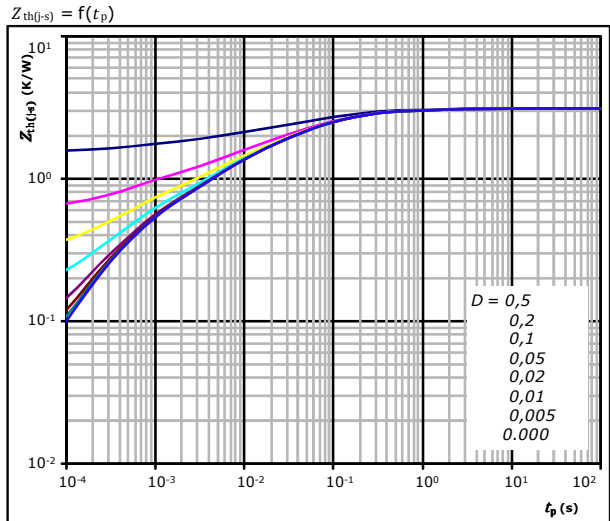
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Inverter Diode Characteristics

Typical forward characteristics FWD



Transient thermal impedance as a function of pulse width FWD



$D = t_p / T$
 $R_{th(j-s)} = 3,10 \text{ K/W}$

FWD thermal model values

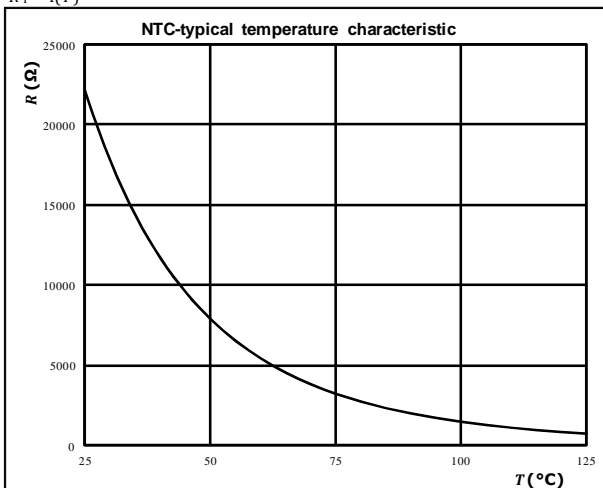
R (K/W)	τ (s)
4,74E-02	7,04E+00
2,14E-01	7,72E-01
9,95E-01	1,01E-01
8,61E-01	2,15E-02
5,97E-01	3,79E-03
3,86E-01	4,43E-04

Thermistor

Thermistor typical temperature characteristic

Typical NTC characteristic
as a function of temperature

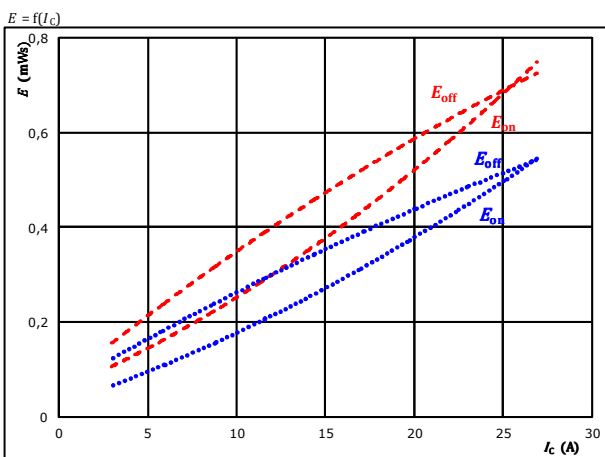
$R_T = f(T)$





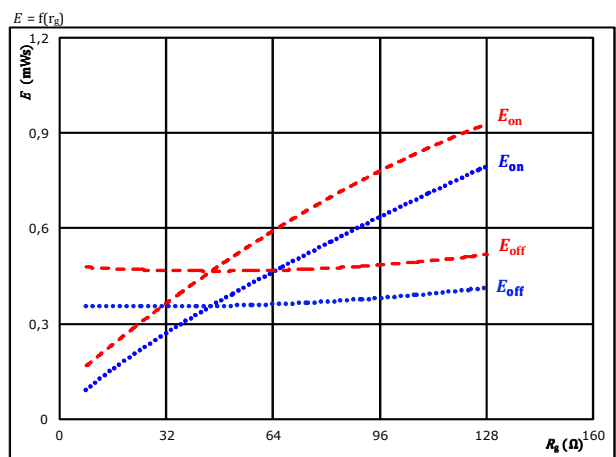
Inverter Switching Characteristics

figure 1. IGBT
Typical switching energy losses as a function of collector current



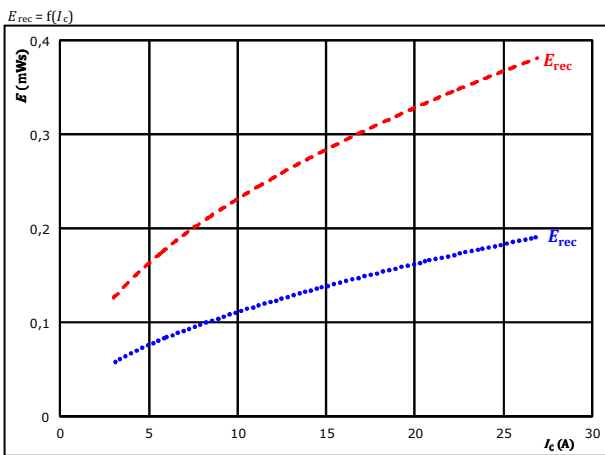
With an inductive load at
 $V_{CE} = 300$ V
 $V_{GE} = \pm 15$ V
 $R_{g\text{on}} = 32$ Ω
 $R_{g\text{off}} = 32$ Ω
 $T_j: 25$ °C (blue dotted)
 150 °C (red dashed)

figure 2. IGBT
Typical switching energy losses as a function of gate resistor



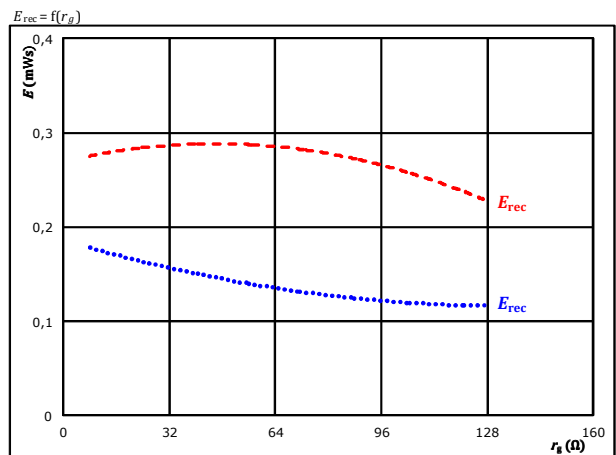
With an inductive load at
 $V_{CE} = 300$ V
 $V_{GE} = \pm 15$ V
 $I_C = 15$ A
 $T_j: 25$ °C (blue dotted)
 150 °C (red dashed)

figure 3. FWD
Typical reverse recovered energy loss as a function of collector current



With an inductive load at
 $V_{CE} = 300$ V
 $V_{GE} = \pm 15$ V
 $R_{g\text{on}} = 32$ Ω
 $T_j: 25$ °C (blue dotted)
 150 °C (red dashed)

figure 4. FWD
Typical reverse recovered energy loss as a function of gate resistor

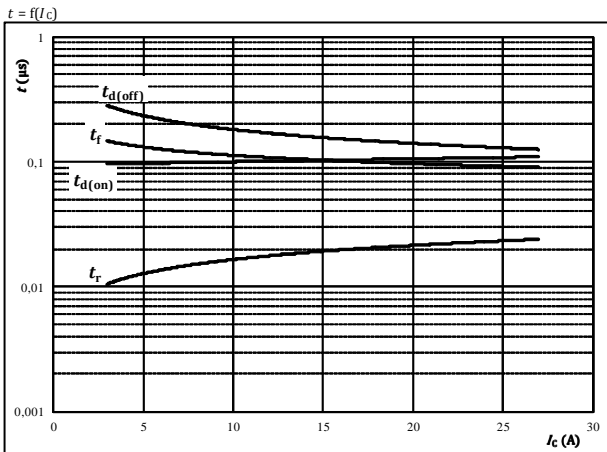


With an inductive load at
 $V_{CE} = 300$ V
 $V_{GE} = \pm 15$ V
 $I_C = 15$ A
 $T_j: 25$ °C (blue dotted)
 150 °C (red dashed)



Inverter Switching Characteristics

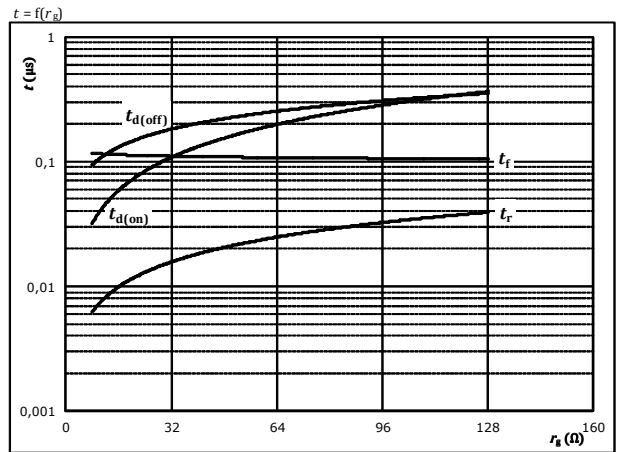
figure 5. IGBT
Typical switching times as a function of collector current



With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	300	V
$V_{GE} =$	±15	V
$R_{g\text{on}} =$	32	Ω
$R_{g\text{off}} =$	32	Ω

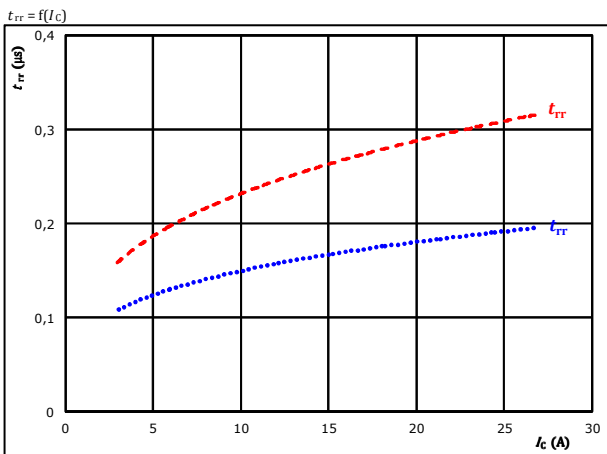
figure 6. IGBT
Typical switching times as a function of gate resistor



With an inductive load at

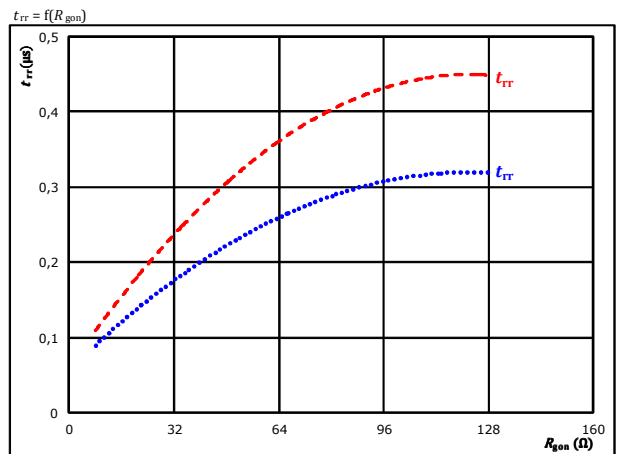
$T_j =$	150	°C
$V_{CE} =$	300	V
$V_{GE} =$	±15	V
$I_C =$	15	A

figure 7. FWD
Typical reverse recovery time as a function of collector current



At	$V_{CE} =$	300	V	$T_j:$	25 °C
	$V_{GE} =$	±15	V		150 °C	-----
	$R_{g\text{on}} =$	32	Ω			

figure 8. FWD
Typical reverse recovery time as a function of IGBT turn on gate resistor



At	$V_{CE} =$	300	V	$T_j:$	25 °C
	$V_{GE} =$	±15	V		150 °C	-----
	$I_C =$	15	A			

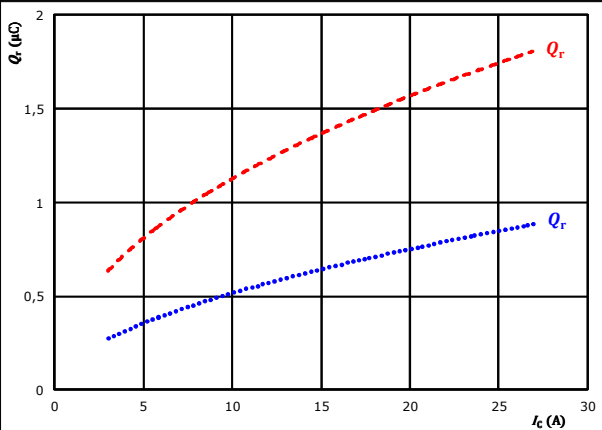


Inverter Switching Characteristics

figure 9. FWD

Typical recovered charge as a function of collector current

$Q_r = f(I_c)$

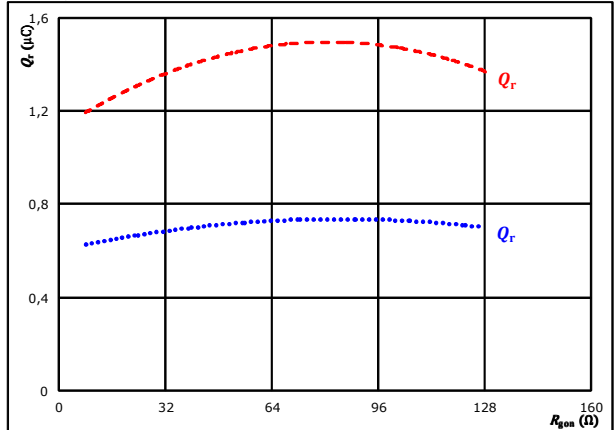


At $V_{CE} = 300$ V
 $V_{GE} = \pm 15$ V
 $R_{gdn} = 32$ Ω
 $T_j: 25$ °C (blue dotted line)
 150 °C (red dashed line)

figure 10. FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$Q_r = f(R_{gdn})$

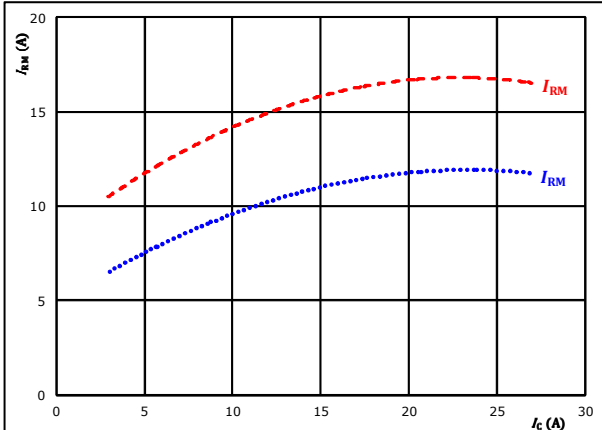


At $V_{CE} = 300$ V
 $V_{GE} = \pm 15$ V
 $I_c = 15$ A
 $T_j: 25$ °C (blue dotted line)
 150 °C (red dashed line)

figure 11. FWD

Typical peak reverse recovery current as a function of collector current

$I_{RM} = f(I_c)$

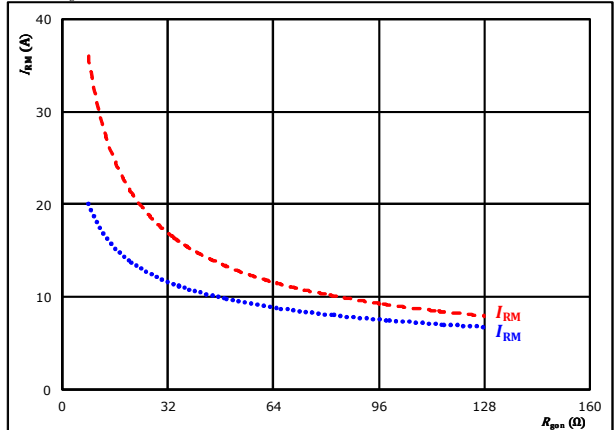


At $V_{CE} = 300$ V
 $V_{GE} = \pm 15$ V
 $R_{gdn} = 32$ Ω
 $T_j: 25$ °C (blue dotted line)
 150 °C (red dashed line)

figure 12. FWD

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$I_{RM} = f(R_{gdn})$



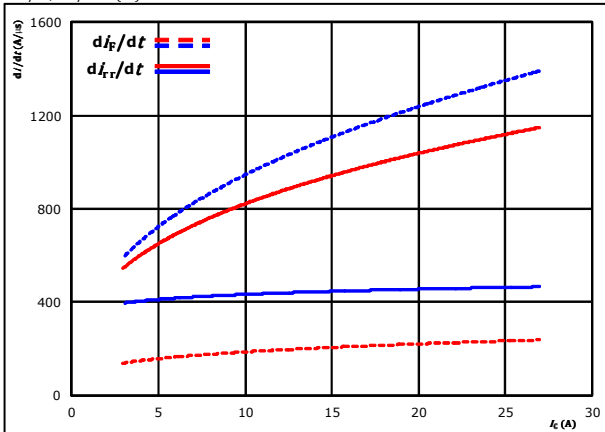
At $V_{CE} = 300$ V
 $V_{GE} = \pm 15$ V
 $I_c = 15$ A
 $T_j: 25$ °C (blue dotted line)
 150 °C (red dashed line)



Inverter Switching Characteristics

figure 13. FWD

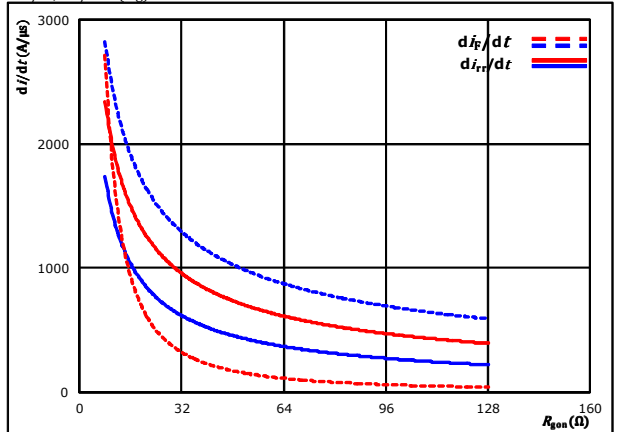
Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_F/dt, di_{rr}/dt = f(I_C)$



At $V_{CE} = 300$ V $T_j = 25$ °C
 $V_{GE} = \pm 15$ V $T_j = 150$ °C - - - - -
 $R_{gon} = 32$ Ω

figure 14. FWD

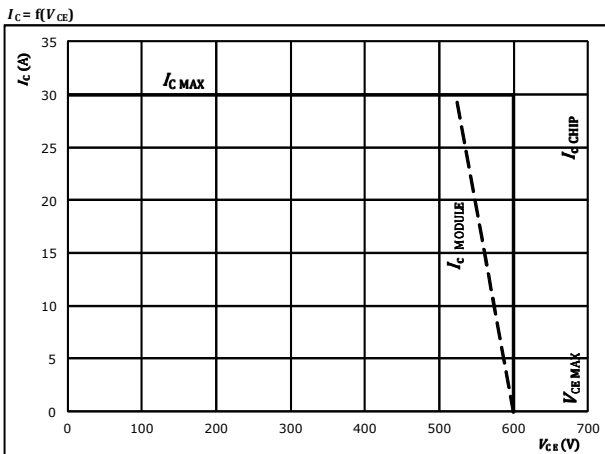
Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor
 $di_F/dt, di_{rr}/dt = f(R_g)$



At $V_{CE} = 300$ V $T_j = 25$ °C
 $V_{GE} = \pm 15$ V $T_j = 150$ °C - - - - -
 $I_C = 15$ A

figure 15. IGBT

Reverse bias safe operating area



At $T_j = 175$ °C
 $R_{gon} = 32$ Ω
 $R_{goff} = 32$ Ω

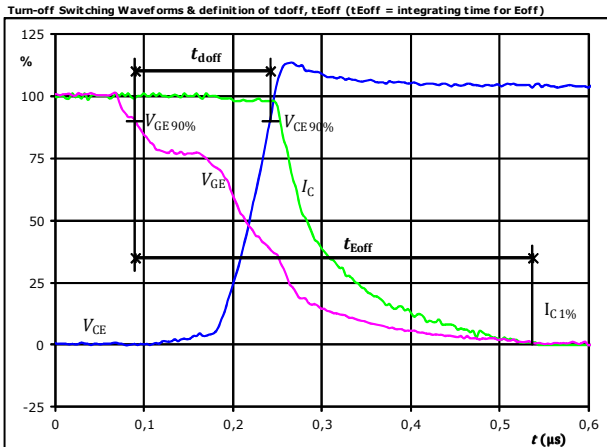


Inverter Switching Definitions

General conditions

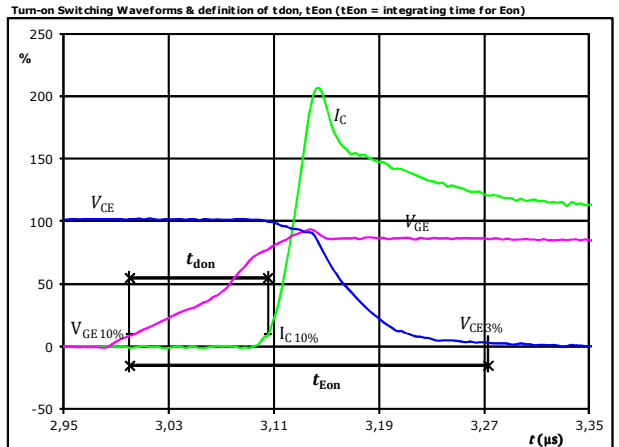
T_j	=	150 °C
R_{gon}	=	32 Ω
R_{goff}	=	32 Ω

figure 1. IGBT



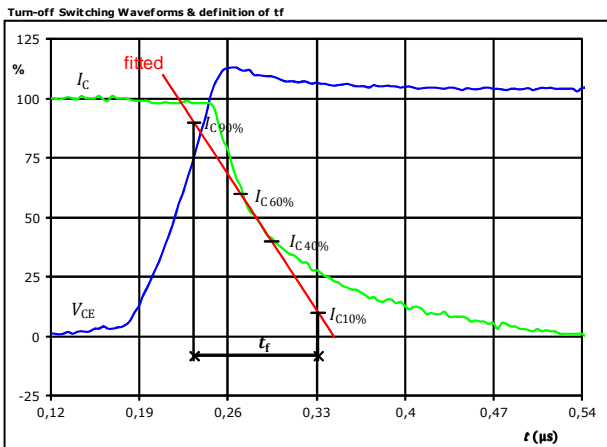
$V_{CE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	300	V
$I_C(100\%) =$	15	A
$t_{doff} =$	0,155	μs
$t_{Eoff} =$	0,447	μs

figure 2. IGBT



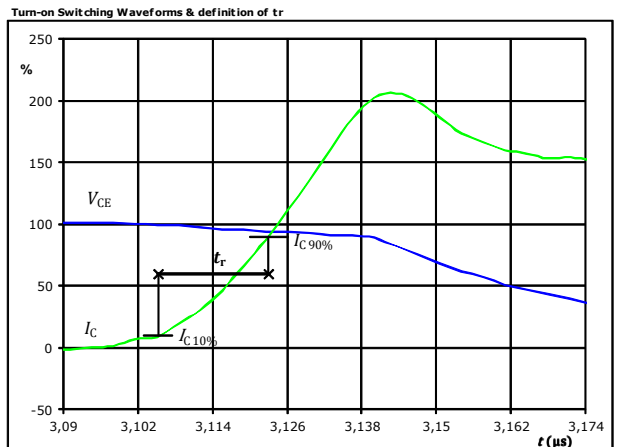
$V_{CE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	300	V
$I_C(100\%) =$	15	A
$t_{don} =$	0,105	μs
$t_{Eon} =$	0,273	μs

figure 3. IGBT



$V_C(100\%) =$	300	V
$I_C(100\%) =$	15	A
$t_f =$	0,109	μs

figure 4. IGBT

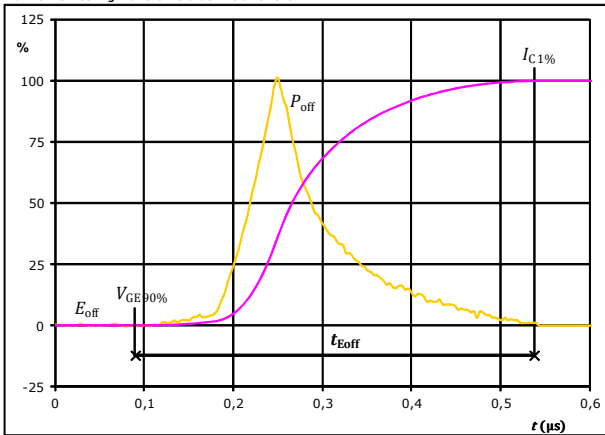


$V_C(100\%) =$	300	V
$I_C(100\%) =$	15	A
$t_r =$	0,018	μs



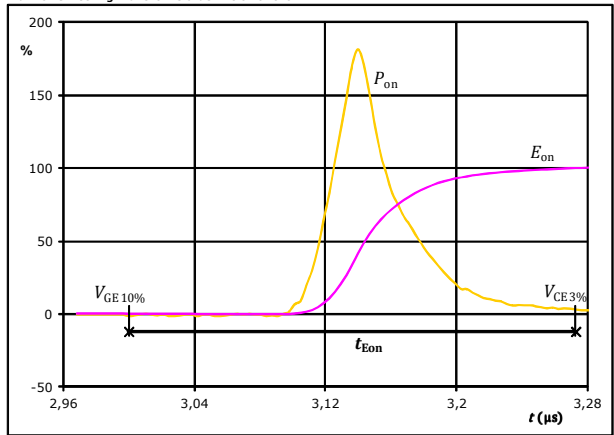
Inverter Switching Definitions

figure 5. IGBT
Turn-off Switching Waveforms & definition of t_{Eoff}



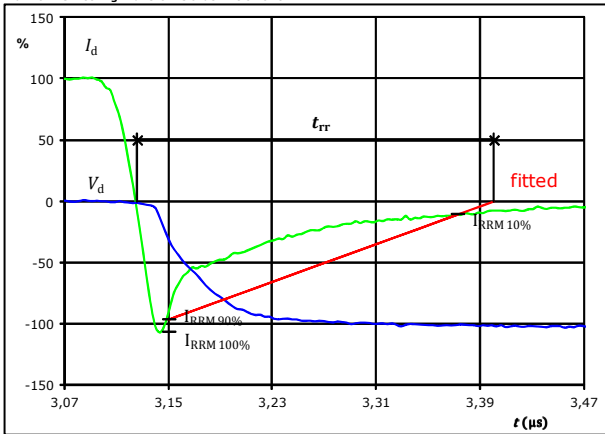
$P_{off}(100\%) = 4,50$ kW
 $E_{off}(100\%) = 0,46$ mJ
 $t_{Eoff} = 0,45$ μs

figure 6. IGBT
Turn-on Switching Waveforms & definition of t_{Eon}



$P_{on}(100\%) = 4,50$ kW
 $E_{on}(100\%) = 0,38$ mJ
 $t_{Eon} = 0,27$ μs

figure 7. FWD
Turn-off Switching Waveforms & definition of t_{tr}

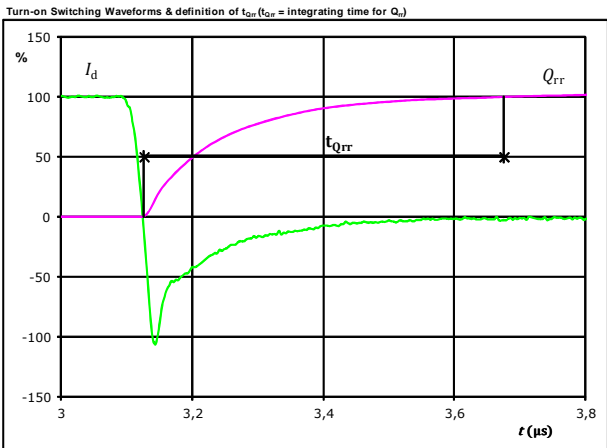


$V_d(100\%) = 300$ V
 $I_d(100\%) = 15$ A
 $I_{RRM}(100\%) = -16$ A
 $t_{tr} = 0,272$ μs



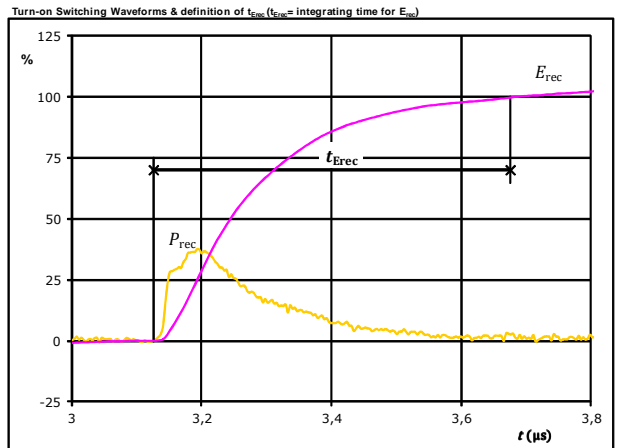
Inverter Switching Definitions

figure 8. FWD



$I_d(100\%) = 15$ A
 $Q_{rr}(100\%) = 1,45$ μ C
 $t_{Qrr} = 0,55$ μ s

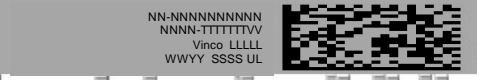
figure 9. FWD



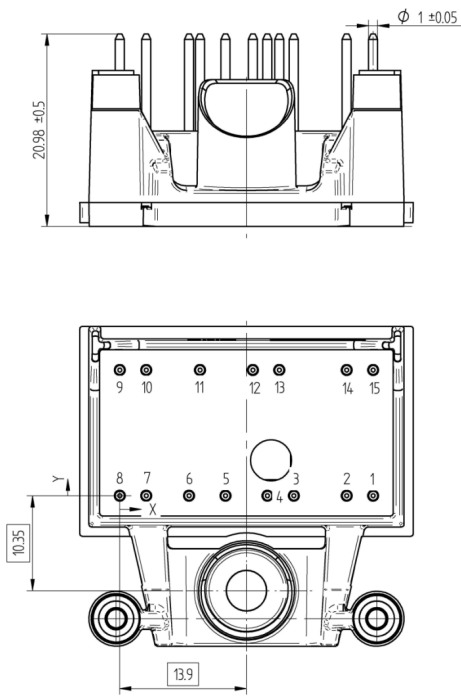
$P_{rec}(100\%) = 4,50$ kW
 $E_{rec}(100\%) = 0,31$ mJ
 $t_{Erec} = 0,55$ μ s



Vincotech

Ordering Code & Marking						
Version			Ordering Code			
without thermal paste with Solder pins 17mm housing			10-0B066PA015SB-M994F09			
						
Text	Name		Type&Ver	Date code	Vinco&Lot	Serial&UL
	NN-NNNNNNNNNNNNNN		TTTTTTTVV	WWYY	Vinco LLLLL	SSSS UL
Datamatrix	Type&Ver	Lot number	Serial	Date code		
	TTTTTTTVV	LLLLL	SSSS	WWYY		

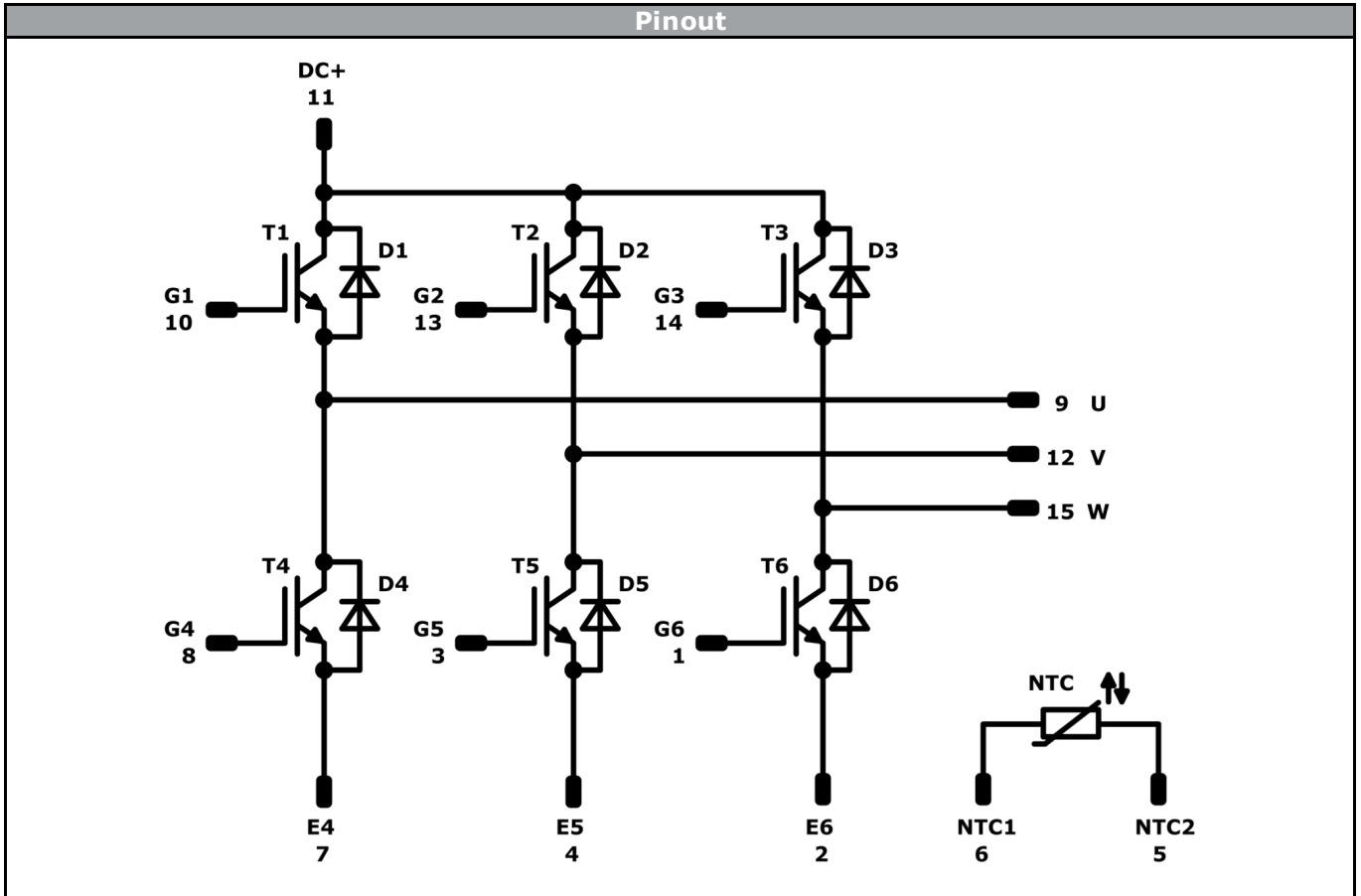
Pin table [mm]			
Pin	X	Y	Function
1	27,8	0	G6
2	24,9	0	E6
3	19,1	0	G5
4	16,2	0	E5
5	11,6	0	NTC2
6	7,6	0	NTC1
7	2,9	0	E4
8	0	0	G4
9	0	13,7	U
10	2,9	13,7	G1
11	8,8	13,7	DC+
12	14,6	13,7	V
13	17,5	13,7	G2
14	24,9	13,7	G3
15	27,8	13,7	W



Tolerance of pinpositions: ±0,5mm at the end of pins
Dimension of coordinate axis is only offset without tolerance
PCB cutouts and holes see in handling instruction document



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Identification					
ID	Component	Voltage	Current	Function	Comment
T1-T6	IGBT	600 V	15 A	Inverter Switch	
D1-D6	FWD	600 V	15 A	Inverter Diode	
NTC	NTC			Thermistor	



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Packaging instruction					
Standard packaging quantity (SPQ)	200	>SPQ	Standard	<SPQ	Sample

Handling instruction	
Handling instructions for <i>flow0</i> B packages see vincotech.com website.	

Package data	
Package data for <i>flow0</i> B packages see vincotech.com website.	

Document No.:	Date:	Modification:	Pages
10-0B066PA015SB-M994F09-D2-14	05 Feb. 2016		

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.